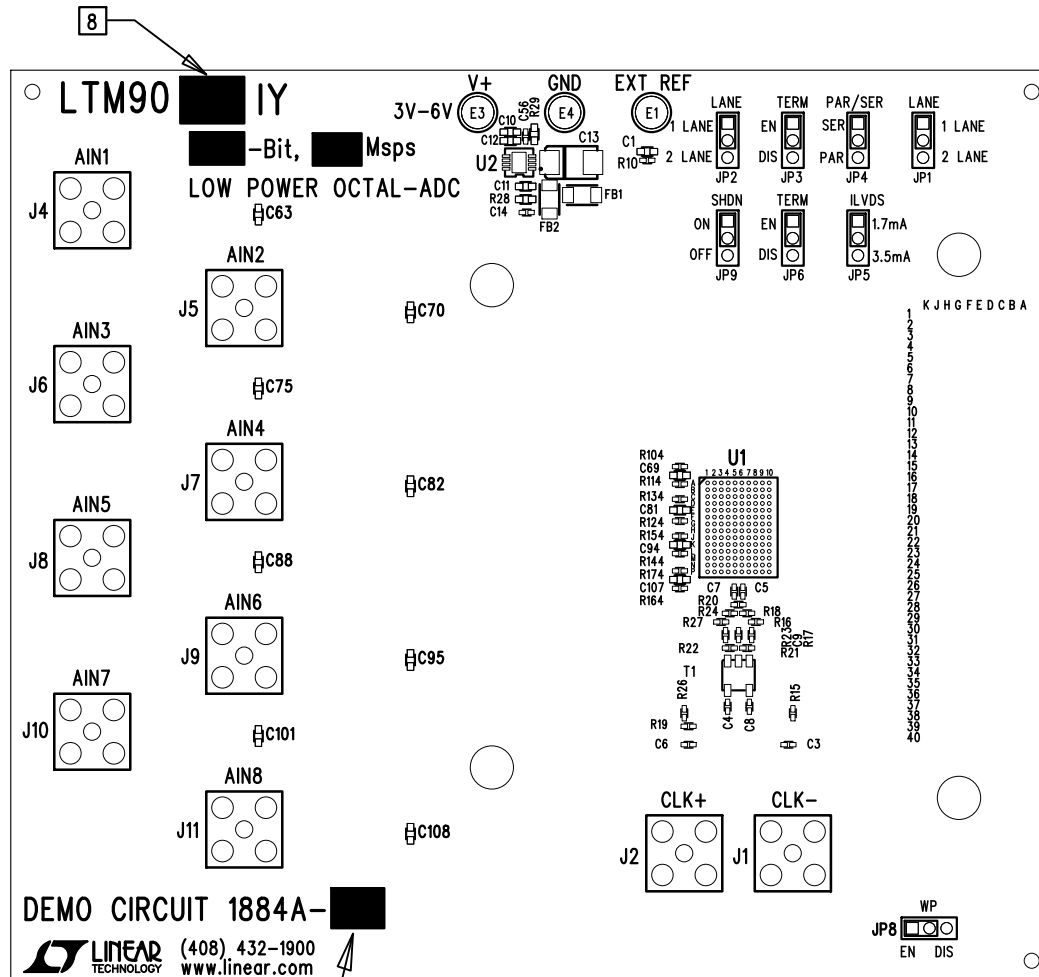
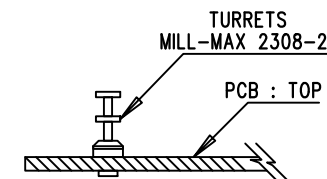


REVISION HISTORY				
ECO	REV	DESCRIPTION	APP. ENG.	DATE
-	2	PRODUCTION	CLARENCE M.	03-20-12



## NOTES: UNLESS OTHERWISE SPECIFIED

- WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
- ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
- PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
- INSTALL SHUNTS AS SHOWN ON BOARD.
- DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
- DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
- INSTALL TURRETS AS SHOWN BELOW:



8. MARK EACH LTC PART NUMBER, Msp, -Bit, AND ASSEMBLY TYPE WITH BLACK PERMANENT MARKER AS SHOWN IN TABLE BELOW:

ASSY	U1	-Bit	Msp
-A	LTM9011Y	14	125
-B	LTM9010Y	14	105
-C	LTM9009Y	14	80
-D	LTM9008Y	14	65
-E	LTM9007Y	14	40
-F	LTM9006Y	14	25

APPROVALS		LINEAR TECHNOLOGY		
PCB DES.	KIM T.	TITLE: TOP ASSEMBLY DRAWING		
APP ENG.	CLARENCE M.			
		LOW POWER OCTAL-ADC		
SIZE	IC NO.	LTM90XXY		REV.
N/A		DEMOCIRCUIT 1884A		2
SCALE = NONE		FILENAME:	DC1884A-2.PCB	SHT 1 OF 2

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